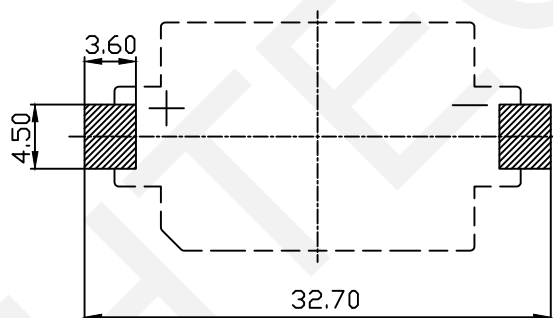
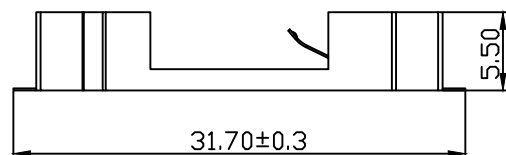
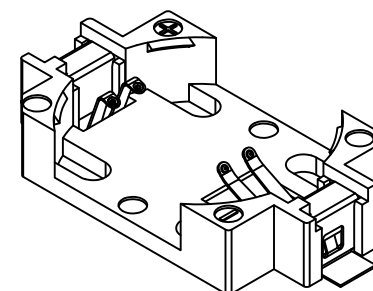
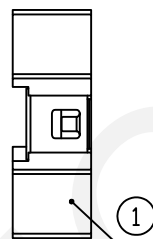
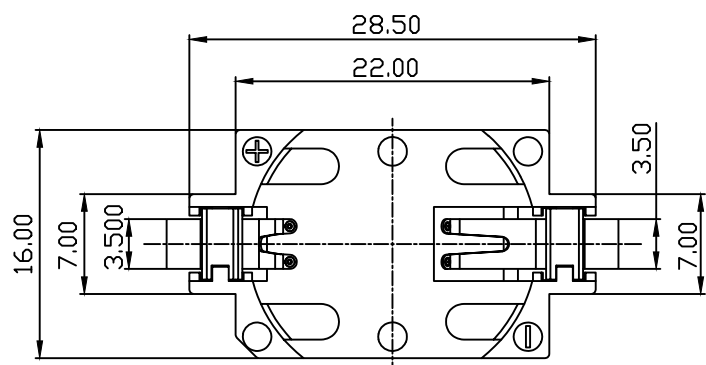




PCB Layout Diagram
Top View

NOTE:

1.MATERIAL:

a.HOUSING:LCP

b.CONTACT:PHOSPHOR BRONZE

(SURFACE PLATING:Su 100u"-120u")

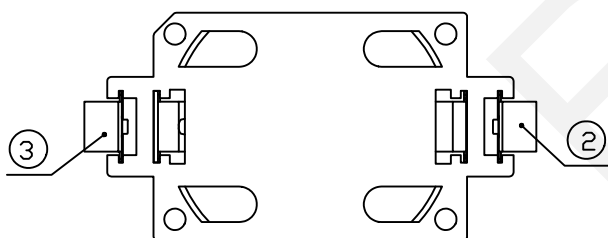
2.ELECTRIC:

a.CONTACT RESISTANCE:50 MILLIOHMS MAX

b.INSULATION RESISTANCE:100 MEA OHMS MIN

c.DIELECTRIC VOLTAGE:500V AC ONE SEC LEVEL

d.OPERATING TEMPERATURE:-25°C~+85°C



3	TERMINAL(-)	1	PHOSPHOR BRONZE,T=0.15mm	Sn Plating
2	TERMINAL(+)	1	PHOSPHOR BRONZE,T=0.15mm	Sn Plating
1	HOUSING	1	LCP	WHITE
NO.	PART NAME	Q'TY	MATERIAL	PLATING &COLOR

RHTECP® NINGBO RHT ELECTRONIC CO.,LTD

UNITS:mm

SHEET SIZE: A4

SCALE:---

DRWN BY PAN

COIN BATTERY HOLDER PCB
MOUNT SUITABLE FOR CR2032 ROHS

0~3

3~18

18~50

50~120

CHK'D BY FENG

THIRD ANGLE PROJECTION

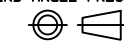
±0.12

±0.15

±0.3

±0.5

APPR BY ZHAN



RE-BH-CR2032-05